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ON Semiconductor®

# FCB20N60F-F085

# N-Channel MOSFET 600V, 20A, 190m $\Omega$

#### **Features**

- Typ  $r_{DS(on)}$  = 171m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 20A
- Typ  $Q_{g(tot)}$  = 78nC at  $V_{GS}$  = 10V,  $I_D$  = 20A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### Description

SuperFET<sup>TM</sup> is ON Semiconductor's proprietary new generation of high voltage MOSFETs utilizing an advanced charge balance mechanism for outstanding low on-resistance and

lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is suitable for various automotive DC/DC power conversion.



### **Applications**

- Automotive On Board Charger
- Automotive DC/DC converter for HEV

#### MOSFET Maximum Ratings T<sub>J</sub> = 25°C unless otherwise noted

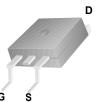
Symbol	Parameter	Ratings	Units	
$V_{DSS}$	Drain to Source Voltage		600	V
$V_{GS}$	Gate to Source Voltage		±30	V
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> = 25°C	20	^
ID	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure4	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	217.8	mJ
В	Power Dissipation		405	W
$P_{D}$	Derate above 25°C		2.7	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 150	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case		0.37	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient	(Note 3)	43	°C/W

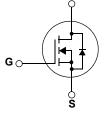
#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCB20N60F	FCB20N60F-F085	TO-263AB	330mm	24mm	800 units

#### Notes

- Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^{\circ}$ C, L = 10mH,  $I_{AS} = 6.6$ A,  $V_{DD} = 100$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche
- 3:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$ is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.





Units

Max

# **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted

**Parameter** 

Off Characteristics							
$B_{VDSS}$	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V$	600	-	-	V	
1	Drain to Source Leakage Current	V <sub>DS</sub> =600V,	$T_J = 25^{\circ}C$	-	-	10	μΑ
IDSS		$V_{GS} = 0V$	$T_J = 150^{\circ} C(Note 4)$	-	-	500	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 30V$		-	-	±100	nA

**Test Conditions** 

Min

Тур

#### **On Characteristics**

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		3.0	4.3	5.0	V
r <sub>DS(on)</sub>	I Irain to Source (In Registance	I <sub>D</sub> = 20A,	$T_J = 25^{\circ}C$	-	171	195	$m\Omega$
		V <sub>GS</sub> = 10V	$T_J = 150^{\circ}C(Note 4)$	-	444	511	mΩ

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz		-	2305	-	pF
C <sub>oss</sub>	Output Capacitance			-	1310	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	105	-	pF
$R_g$	Gate Resistance	f = 1MHz		-	0.95	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	V <sub>DD</sub> = 300V	-	78	102	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 2V$ $I_D = 20A$		-	6.6	8.6	nC
$Q_{gs}$	Gate to Source Gate Charge		_	-	13.8	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge			-	41.5	-	nC

# **Switching Characteristics**

t <sub>on</sub>	Turn-On Time	V <sub>DD</sub> = 300V, I <sub>D</sub> = 20A,	-	-	176	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	43	-	ns
t <sub>r</sub>	Rise Time		-	66	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_G = 25\Omega$	-	211	-	ns
t <sub>f</sub>	Fall Time		-	42	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	403	ns

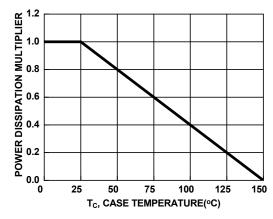
#### **Drain-Source Diode Characteristics**

$V_{SD}$	Source to Drain Diode Voltage	I <sub>SD</sub> = 20A, V <sub>GS</sub> = 0V	-	-	1.4	V
T <sub>rr</sub>	Reverse Recovery Time	$I_F = 20A, dI_{SD}/dt = 100A/\mu s,$	-	163	-	ns
$Q_{rr}$	Reverse Recovery Charge	V <sub>DD</sub> =480V	-	1285	-	nC

#### Notes

4: The maximum value is specified by design at  $T_J$  = 150°C. Product is not tested to this condition in production.

# **Typical Characteristics**



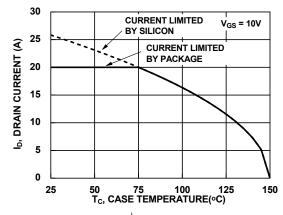
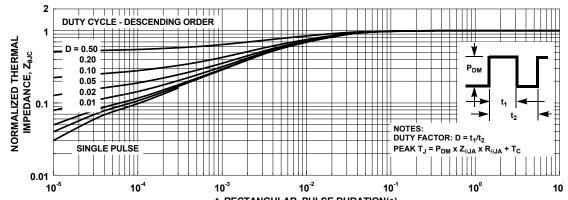


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. Maximum Continuous Drain Current vs Case Temperature



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Figure 3. Normalized Maximum Transient Thermal Impedance

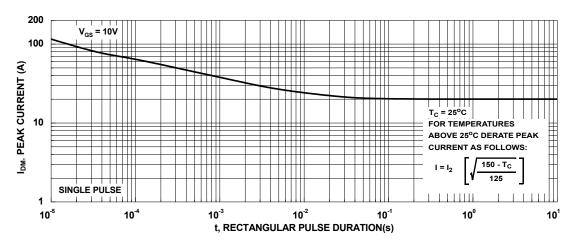


Figure 4. Peak Current Capability

# **Typical Characteristics**

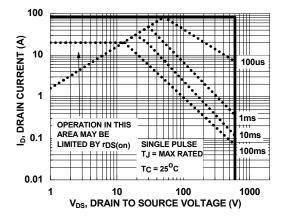


Figure 5. Forward Bias Safe Operating Area

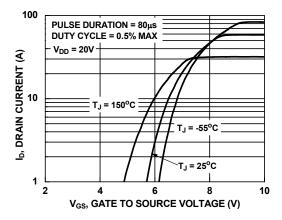


Figure 6. Transfer Characteristics

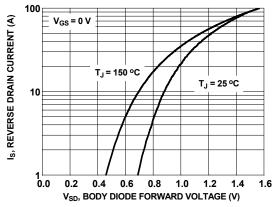


Figure 7. Forward Diode Characteristics

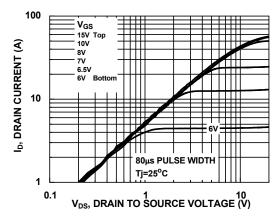


Figure 8. Saturation Characteristics

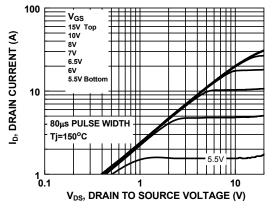


Figure 9. Saturation Characteristics

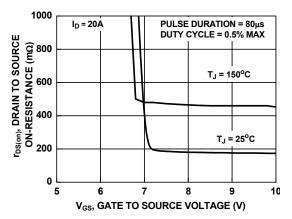
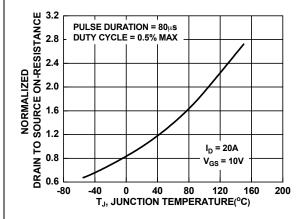


Figure 10. Rdson vs Gate Voltage

# **Typical Characteristics**



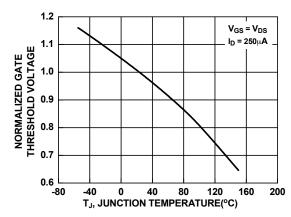


Figure 11. Normalized Rdson vs Junction Temperature

Figure 12. Normalized Gate Threshold Voltage vs
Temperature

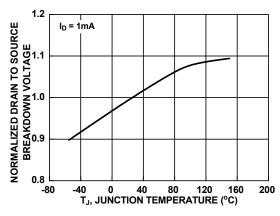


Figure 13. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

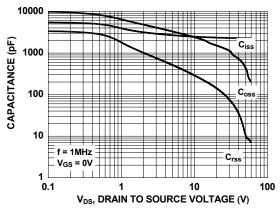


Figure 14. Capacitance vs Drain to Source Voltage

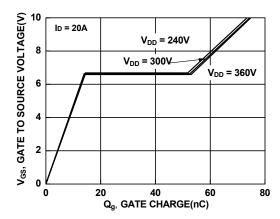


Figure 15. Gate Charge vs Gate to Source Voltage

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